



PATENT
Atty. Dkt. No. AMAT/5262/CMP/CMP/RKK

6P1753
Rfw

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:
Tsai, et al.

Serial No.: 09/961,134

Confirmation No.: 4110

Filed: September 21, 2001

For: Method and Apparatus For
Forming Metal Layers

§§§§§ Group Art Unit: 1753

§§§§§ Examiner: Wong, Edna

MAIL STOP Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

CERTIFICATE OF MAILING 37 CFR 1.8

I hereby certify that this correspondence is being deposited on
August 25, 2004 with the United States Postal Service as First
Class Mail in an envelope addressed to: Commissioner for
Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

8/25/04

Date

Signature

Dear Sir:

RESPONSE TO OFFICE ACTION DATED JUNE 17, 2004

In response to the Office Action dated June 17, 2004, having a shortened statutory period for response set to expire on September 17, 2004, please enter this response and reconsider the claims pending in the application for reasons discussed below. Although Applicant believes that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/AMAT/5262/KMT, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper. **Remarks** begin on page 4 of this paper.